

April 1988 Revised August 2000

74F32

Quad 2-Input OR Gate

General Description

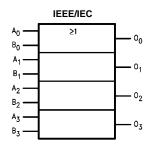
This device contains four independent gates, each of which performs the logic OR function.

Ordering Code:

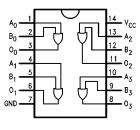
		,
Order Number	Package Number	Package Description
74F32SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
74F32SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F32MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74F32PC	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I _{IH} /I _{IL} Output I _{OH} /I _{OL}		
A _n , B _n	Inputs	1.0/1.0	20 μA/-0.6 mA		
O _n	Outputs	50/33.3	−1 mA/20 mA		

Absolute Maximum Ratings(Note 1)

 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \end{array}$

Voltage Applied to Output in HIGH State (with $V_{CC} = 0V$)

Input Current (Note 2)

 $\begin{array}{ll} \mbox{Standard Output} & -0.5\mbox{V to V}_{\mbox{CC}} \\ \mbox{3-STATE Output} & -0.5\mbox{V to } +5.5\mbox{V} \end{array}$

-30 mA to +5.0 mA

Current Applied to Output

Recommended Operating Conditions

Free Air Ambient Temperature 0°C to +70°C Supply Voltage +4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

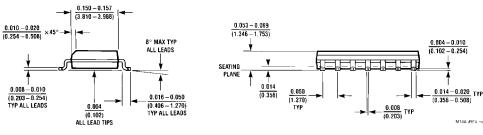
Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

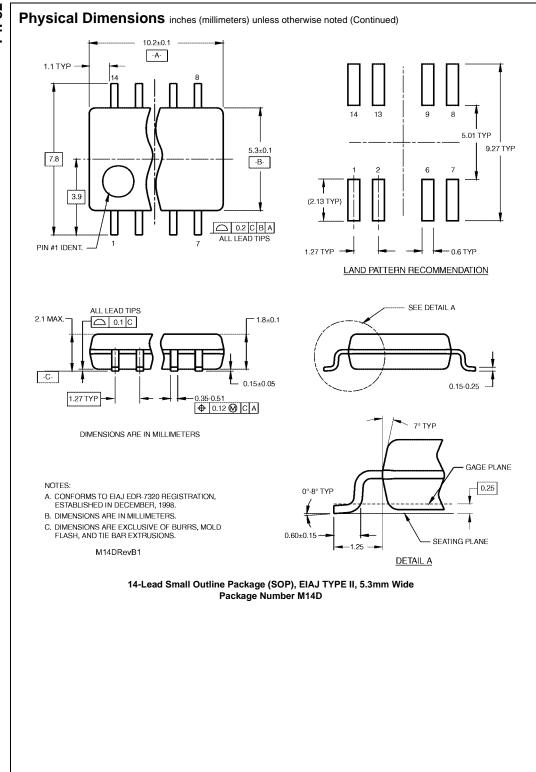
Symbol	Parameter		Min	Тур	Max	Units	v _{cc}	Conditions	
V _{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V _{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal	
V _{CD}	Input Clamp Diode Voltage				-1.2	V	Min	I _{IN} = -18 mA	
V _{OH}	Output HIGH 10	% V _{CC}	2.5			V	Min	I _{OH} = -1 mA	
	Voltage 5	% V _{CC}	2.7					$I_{OH} = -1 \text{ mA}$	
V _{OL}	Output LOW 10	10% V _{CC}			0.5	V	Min	I _{OL} = 20 mA	
	Voltage				0.5			I _{OL} = 20 IIIA	
I _{IH}	Input HIGH				5.0	μА	Max	V _{IN} = 2.7V	
	Current				3.0	μА			
I _{BVI}	Input HIGH Current				7.0	μА	Max	V _{IN} = 7.0V	
	Breakdown Test				7.0			V _{IN} = 7.0 V	
I _{CEX}	Output HIGH				50	μА	Max	V _{OUT} = V _{CC}	
	Leakage Current								
V _{ID}	Input Leakage		4.75			٧	0.0	I _{ID} = 1.9 μA	
	Test							All Other Pins Grounded	
I _{OD}	Output Leakage				3.75	μА	0.0	V _{IOD} = 150 mV	
	Circuit Current				3.73	μΛ	0.0	All Other Pins Grounded	
I _{IL}	Input LOW Current				-0.6	mA	Max	$V_{IN} = 0.5V$	
I _{OS}	Output Short-Circuit Current		-60		-150	mA	Max	V _{OUT} = 0V	
I _{CCH}	Power Supply Current			6.1	9.2	mA	Max	V _O = HIGH	
I _{CCL}	Power Supply Current			10.3	15.5	mA	Max	$V_O = LOW$	

AC Electrical Characteristics

Symbol	Parameter	$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$			$T_{A} = -55^{\circ}\text{C to } +125^{\circ}\text{C}$ $V_{CC} = +5.0\text{V}$ $C_{L} = 50 \text{ pF}$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$ $C_L = 50$ pF		Units	
		Min	Тур	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay	3.0	4.2	5.6	3.0	7.5	3.0	6.6	ns	
t _{PHL}	A _n , B _n to O _n	3.0	4.0	5.3	2.5	7.5	3.0	6.3	115	

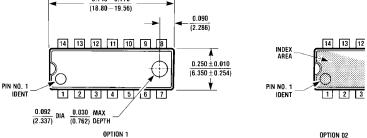


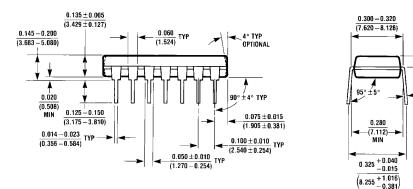
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow Package Number M14A



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 5.0±0.1 -A-7.72 4.16 6.4 4.4±0.1 -B-3.2 0.2 C B A 0.65 ALL LEAD TIPS LAND PATTERN RECOMMENDATION PIN #1 IDENT. - SEE DETAIL A ALL LEAD TIPS 1.2 MAX - 0.90 +0.15 - 0.09-0.20 -C-- 0.10±0.05 0.19 - 0.30 **♦** 0.13 **№** A B**⑤** C**⑤** -12.00° TOP & BOTTOM R0.09 MIN-GAGE PLANE NOTES: A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATE 7/93. 0.25 B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. SEATING PLANE D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982. -1.00-R0.09 MIN MTC14RevC3 DETAIL A 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N14A

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 $\frac{0.008 - 0.016}{(0.203 - 0.406)}$ TYP

N144 (REV.F)